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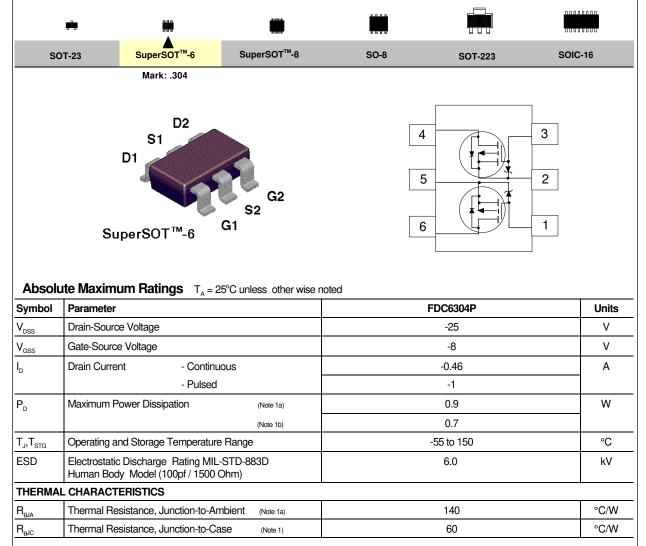
FDC6304P Digital FET, Dual P-Channel

General Description

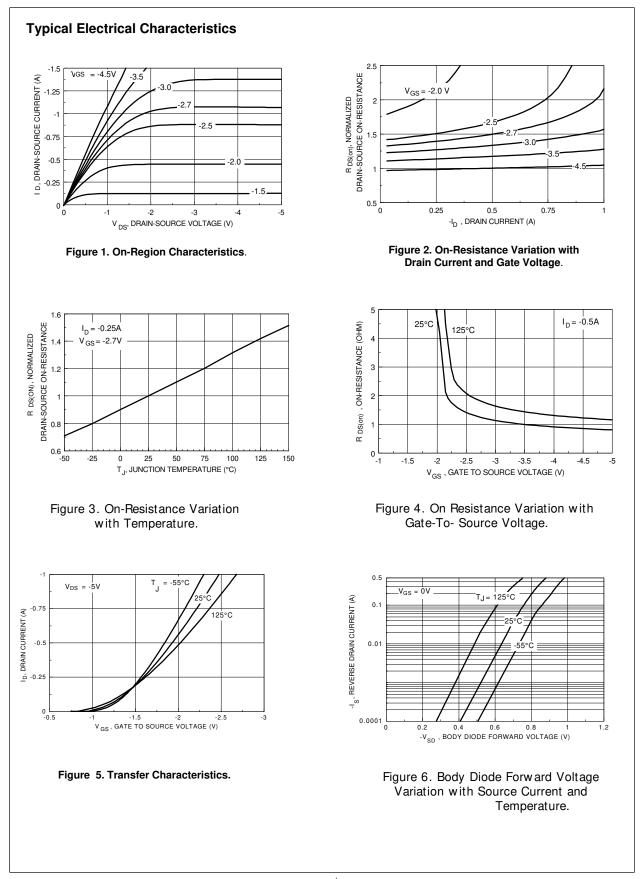
These P-Channel enhancement mode field effect transistor are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process is tailored to minimize on-state resistance at low gate drive conditions. This device is designed especially for application in battery power applications such as notebook computers and cellular phones. This device has excellent on-state resistance even at gate drive voltages as low as 2.5 volts.

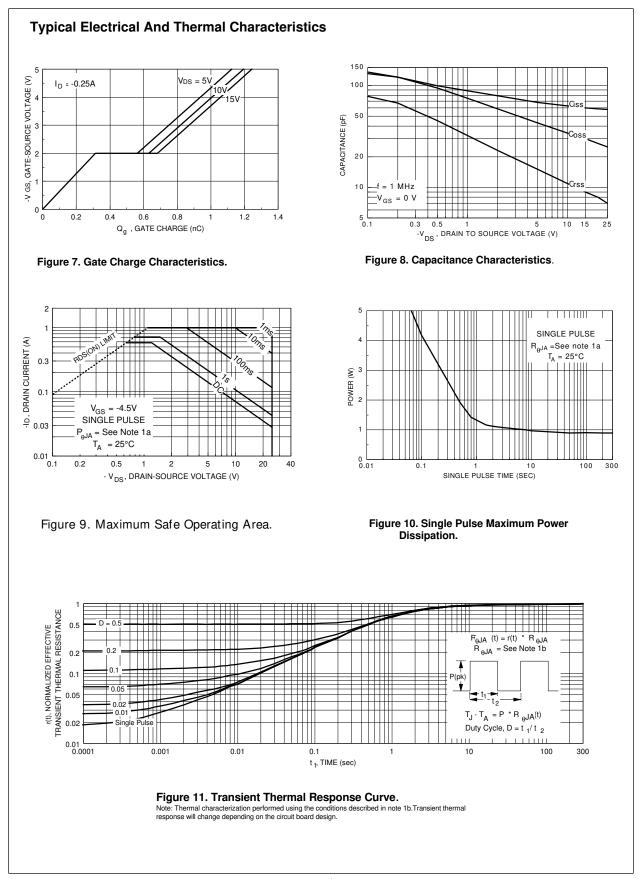
Features

- -25 V, -0.46 A continuous, -1.0 A Peak. $R_{DS(ON)} = 1.5 \Omega @ V_{GS} = -2.7 V$ $R_{DS(ON)} = 1.1 \Omega @ V_{GS} = -4.5 V.$
- Very low level gate drive requirements allowing direct operation in 3V circuits. V_{GS(th)} < 1.5 V.
- Gate-Source Zener for ESD ruggedness.
 >6kV Human Body Model.



Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAF	RACTERISTICS			•		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-25			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I_{D} = -250 μ A, Referenced to 25 °C		-22		mV /°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ $T_{J} = 55^{\circ}\text{C}$			-1	μA
					-10	μA
GSS	Gate - Body Leakage Current	$V_{GS} = -8 V, V_{DS} = 0 V$			-100	nA
ON CHARA	CTERISTICS (Note 2)					
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{\rm D}$ = -250 μ A, Referenced to 25 °C		2.1		mV /°C
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \ I_{D} = -250 \ \mu A$	-0.65	-0.86	-1.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -2.7 \text{ V}, \ \text{I}_{\text{D}} = -0.25 \text{ A}$		1.22	1.5	Ω
		$V_{GS} = -4.5 \text{ V}, I_{D} = -0.5 \text{ A}$	0.87	1.1]	
			;	1.21	2	1
I _{D(ON)}	On-State Drain Current	$V_{GS} = -2.7 \text{ V}, \ V_{DS} = -5 \text{ V}$	-0.5			A
		$V_{GS} = -4.5 \text{ V}, \ V_{DS} = -5 \text{ V}$	-1			
g _{fs}	Forward Transconductance	$V_{DS} = -5 V, I_{D} = -0.5 A$		0.8		S
DYNAMIC (CHARACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1.0 MHz		62		pF
C _{oss}	Output Capacitance			35		pF
C _{rss}	Reverse Transfer Capacitance			9.5		pF
SWITCHING	G CHARACTERISTICS (Note 2)				1	
t _{D(on)}	Turn - On Delay Time	$V_{DD} = -6 \text{ V}, \text{ I}_{D} = -0.5 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 50 \Omega$		7	20	ns
t,	Turn - On Rise Time			8	20	ns
t _{D(off)}	Turn - Off Delay Time			55	110	ns
t _r	Turn - Off Fall Time			35	70	ns
Q _g	Total Gate Charge	$\frac{V_{DS} = -5 \text{ V}, \text{ I}_{D} = -0.25 \text{ A},}{V_{GS} = -4.5 \text{ V}}$		1.1	1.5	nC
Q _{gs}	Gate-Source Charge			0.32		nC
Q _{gd}	Gate-Drain Charge			0.28		nC
DRAIN-SOU	JRCE DIODE CHARACTERISTICS AND MA	KIMUM RATINGS		-		
s	Maximum Continuous Drain-Source Diode Fo	orward Current			-0.5	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{\rm GS} = 0 \ V, \ I_{\rm S} = -0.5 \ A \ ({\rm Note} \ 2)$		-0.88	-1.2	V
		2/W on a 0.005 in ² of pad z copper.				





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